

Fig. 1

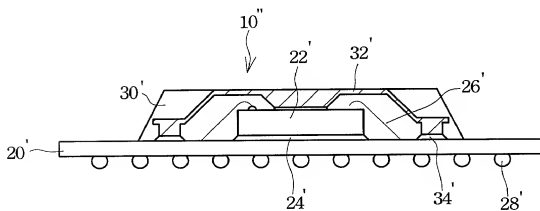


Fig. 2

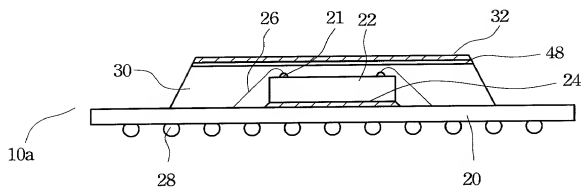


Fig. 3

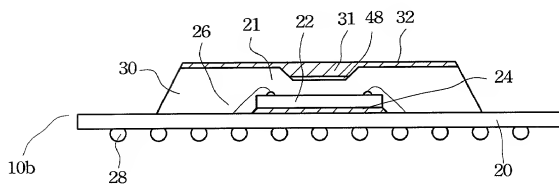
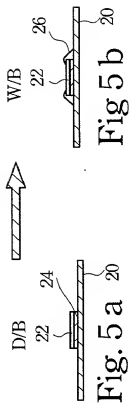


Fig. 4



Title: Structure of Heat Slug-Equipped Packages
and the Packaging Method of The Same
Inventor: Jung-Yu Lee, et al.
U.S. Appln. No. Unknown

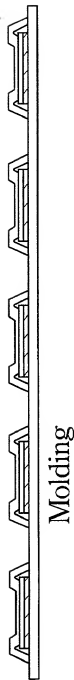
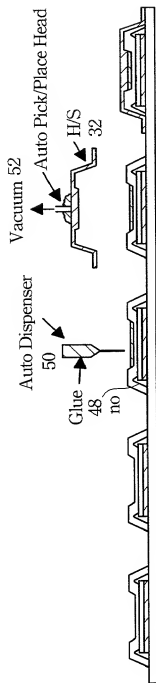
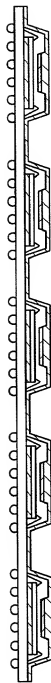


Fig. 5 c



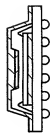
Assembly

Fig. 5 d



Ball Placement

Fig. 5 e



Singulation

Fig. 5 f